

Special Issue

State of the Art in Smart Materials and Flexible Sensors

Message from the Guest Editors

This Special Issue aims to showcase the latest advancements in the field of smart materials and flexible sensors. Smart materials, with their ability to adapt to external stimuli, are driving innovations in sensor technologies, particularly flexible sensors, which offer new possibilities for monitoring, healthcare, environmental control, and industrial applications. This Special Issue welcomes the submission of research articles, reviews, and short communications focusing on breakthroughs in material design, fabrication techniques, applications, and integration strategies that push the boundaries of current sensor technologies.

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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

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